PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data			
1.1 Company		STMicroelectronics International N.V	
1.2 PCI No.		AMS/19/11313	
1.3 Title of PCI		New assembly process sequence in SOIC 18 lead for devices assembled in CIRTEK including single DTFS tool (Deflash, Trim, Form and Singulation)	
1.4 Product Category		See product list	
1.5 Issue date		2019-02-03	

2. PCI Team		
2.1 Contact supplier	2.1 Contact supplier	
2.1.1 Name	MARCELI SMIALKOWSKI	
2.1.2 Phone	+44 1628896277	
2.1.3 Email	marceli.smialkowski@st.com	
2.2 Change responsibility		
2.2.1 Product Manager Lorenzo NASO		
2.1.2 Marketing Manager	Marcello SAN BIAGIO	
2.1.3 Quality Manager	Sergio Tommaso SPAMPINATO	

3. Change			
3.1 Category 3.2 Type of change		3.3 Manufacturing Location	
Methods	Process flow chart: Revision change in Process (process technology, sawing, die attach, plasma, capillary, marking, packing, labelling, transportation, etc)	CIRTEK Elecctronics Corp., Philippines	

4. Description of change		
	Old	New
4.1 Description	SOIC 18L process with separed process step/tools for Defflash/Trim and Form/Singulation	SOIC 18L assembly process with separed process step/tools for Defflash/Trim and Form/Singulation SOIC 18L assembly process with Deflash/Trim/ Form/ Singulation -progressive process tool
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change	
5.1 Motivation	Progressing on the activities related to our service continuous improvement, ST is glad to announce the introduction of a new assembly process sequence for ST SOIC 18 leads devices assembled in CIRTEK, Philippines as additional option to increase the volume loading in assembly line.
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change		
	No change in marking, traceability guaranteed by new dedicated genealogy (Raw Line and Finished Good codes)	

7. Timing / schedule		
7.1 Date of qualification results 2019-01-17		
7.2 Intended start of delivery	2019-03-01	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation	
8.1 Description	11313 Cirtek SOIC18L new flow with DTFS tool_report.pdf

	Available (see attachment)	Issue	2019-02-03
qualification results		Date	

I	9. Attachments (additional documentations)
	11313 Public product.pdf 11313 Cirtek SOIC18L new flow with DTFS tool_report.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	M41T83RMY6F	
	M41T93RMY6F	

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Public Products List

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PCI Title: New assembly process sequence in SOIC 18 lead for devices assembled in CIRTEK including single DTFS tool

(Deflash, Trim, Form and Singulation)

PCI Reference: AMS/19/11313

Subject: Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

M41T83ZMY6F	M41T93SMY6F	M41T93RMY6F
M41T83RMY6F	M41T83SMY6F	M41T93ZMY6F
M41T81SMY6F		

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